

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

46. (Previously Presented) In an electronic card assembly, wherein the improvement comprises said electronic card assembly withstanding a rotating angle of greater than approximately 10° during a torque test which applies a torque of greater than approximately 1.2N-m, and wherein the electronic card assembly does not include a printed circuit board during the torque test.

47. (Previously Presented) The electronic card assembly according to claim 46, wherein said electronic card assembly can withstand a rotating angle of approximately 12° .

48. (Canceled).

49. (Currently Amended) In an electronic card assembly, wherein the improvement comprises said electronic card assembly deflecting less than approximately 3.5mm when ~~the PCMCIA standard during a PCMCIA bend test which applies a force of~~ approximately 20N is applied to an end of the electronic card assembly.

50. (Currently Amended) The electronic card assembly as recited in claim 49, wherein said electronic card assembly ~~deflects less than approximately 3.5mm during said PCMCIA bend test, and wherein the electronic card assembly does not include a printed circuit board during the PMCIA bend test.~~

51. (Canceled).

52. (Currently Amended) In an electronic card assembly, wherein the improvement comprises said card displacing less than approximately 1.5mm ~~the PCMCIA standard during a fingernail test which applies~~ when a force of more than approximately 100N

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is applied to a mating seam of two halves of the electronic card assembly, and wherein the electronic card assembly does not include a printed circuit board during the fingernail test.

53. (Canceled).